Electronic Acknowledgement Receipt					
EFS ID:	5568558				
Application Number:	10599661				
International Application Number:					
Confirmation Number:	2432				
Title of Invention:	Palladium-Plated Lead Finishing Structure For Semiconductor Part And Method Of Producing Semiconductor Device				
First Named Inventor/Applicant Name:	Kazumitsu Seki				
Customer Number:	54205				
Filer:	Walter G. Hanchuk				
Filer Authorized By:					
Attorney Docket Number:	17314-018				
Receipt Date:	23-JUN-2009				
Filing Date:	04-OCT-2006				
Time Stamp:	14:02:12				
Application Type:	U.S. National Stage under 35 USC 371				
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Submitted with Payment	yes
Payment Type	Credit Card
Payment was successfully received in RAM	\$130
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/ Message Digest	Multi Part /.zip	Pages (if appl.)
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	Amendment/Req. Reconsideration-After	17314_018_OAR_Seki.pdf	101510	no	9
Non-Final Reject	Non-Final Reject		8feabb75fe69c5e41e71756f84762c0b0121 6829		
Warnings:					
Information	:				
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Warnings:					
Information	:				_
Drawings-only black and white line	17314_018_Drawings.pdf	96222	no	2	
J	drawings	17314_010_b1awiiigs.pai	51307d67c378b9c5242464932ef7aed3e73 3da0a		2
Warnings:					
Information	:				
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Tee Worksheet (110 075)	ree illo.pai	ea963d27f074acede29c920b454a435fbd9 85f97			
Warnings:					
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If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.

New International Application Filed with the USPTO as a Receiving Office

If a new international application is being filed and the international application includes the necessary components for an international filing date (see PCT Article 11 and MPEP 1810), a Notification of the International Application Number and of the International Filing Date (Form PCT/RO/105) will be issued in due course, subject to prescriptions concerning national security, and the date shown on this Acknowledgement Receipt will establish the international filing date of the application.